LTCC SMT

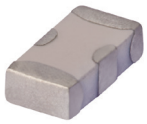
Band Pass Filter

BFCN-3010+

50Ω 2920 to 3100 MHz

THE BIG DEAL

- Good Rejection, 30dB Typ.
- Low Return Loss, 12.7dB Typ.
- 1206 Surface Mount Footprint
- Power Handling: 1.5 Watts



Generic photo used for illustration purposes only

CASE STYLE: FV1206

+RoHS Compliant
The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

APPLICATIONS

- Harmonic Rejection
- Transmitters / Receivers
- Point-to-Point Communications

PRODUCT OVERVIEW

Mini-Circuits' BFCN-3010+ LTCC Band Pass Filter is constructed with multiple layers in order to achieve a miniature size and high repeatability of performance. Wrap-around terminations minimize variations in performance due to parasitics. Covering 180 MHz passband, these units offer low insertion loss and good rejection.

KEY FEATURES

Feature	Advantages
Small Size , 1206	Allows for high layout density of circuit boards, while minimizing the effects of parasitics.
Wrap around termination	Provides excellent solderability and easy visual inspection capability.
LTCC construction	Provides a rugged package that is well suited for tough environments including high humidity and high temperature extremes.
Rugged Power handling	Handles up to 1.5 Watts in a small package.

REV. B
ECO-016659
BFCN-3010+
URJ
230202

Band Pass Filter

BFCN-3010+

ELECTRICAL SPECIFICATIONS[1,2] AT 25°C

Parameter		F#	Frequency (MHz)	Min.	Typ.	Max.	Units
Passband	Center Frequency	—	—	—	3010	—	MHz
	Insertion Loss	F1-F2	2920 - 3100	—	—	6	dB
	Return Loss	F1-F2	2920 - 3100	6.0	12.7	—	dB
Stop Band, Lower	Rejection	DC-F3	DC - 1300	—	30	—	dB
		DC-F4	DC - 1530	20	—	—	
Stop Band, Upper	Rejection	F5-F6	4450 - 4650	20	—	—	dB
		F6-F7	4650 - 6600	—	30	—	

1. This component should not be used as a DC-block. In applications where DC voltage and/or current is present at either the input or output ports, external DC blocking capacitors are required.

2. Measured on Mini-Circuits Characterization Test Board TB-270.

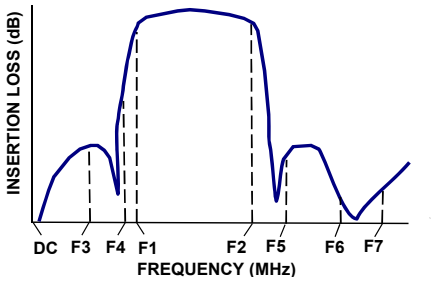
ABSOLUTE MAXIMUM RATINGS[1]

Parameter	Ratings
Operating temperature	-55°C to 100°C
Storage temperature	-55°C to 100°C
RF Power Input[2]	1.5W @25°C

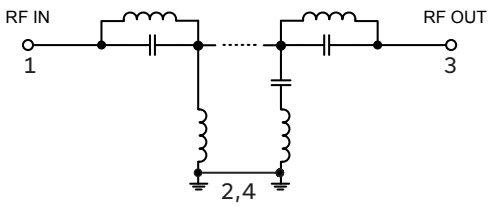
1. Permanent damage may occur if any of these limits are exceeded.

2. Power rating applies only to signals within the passband. Power rating above +25°C operating temperature decreases linearly to 0.25W at +100°C

TYPICAL FREQUENCY RESPONSE



FUNCTIONAL DIAGRAM



Band Pass Filter

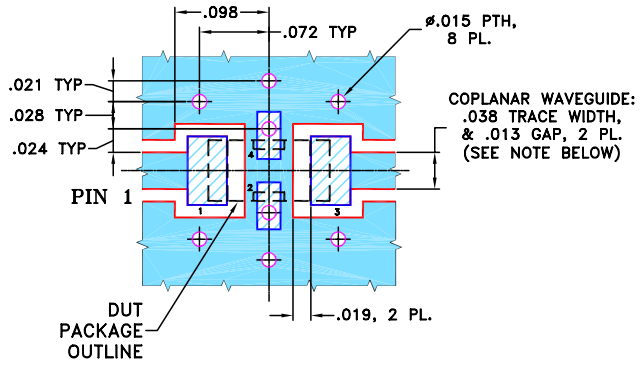
BFCN-3010+

PAD CONNECTIONS

RF IN	1
RF OUT	3
GROUND	2,4

PRODUCT MARKING: RK

DEMO BOARD MCL P/N: TB-270
SUGGESTED PCB LAYOUT (PL-137)

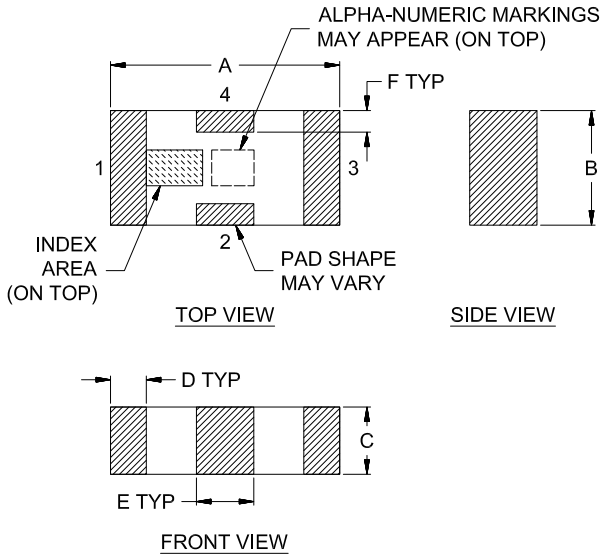


NOTES:
1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS RO4350B WITH THICKNESS .020" ± .0015". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

OUTLINE DRAWING



OUTLINE DIMENSIONS (Inches / mm)

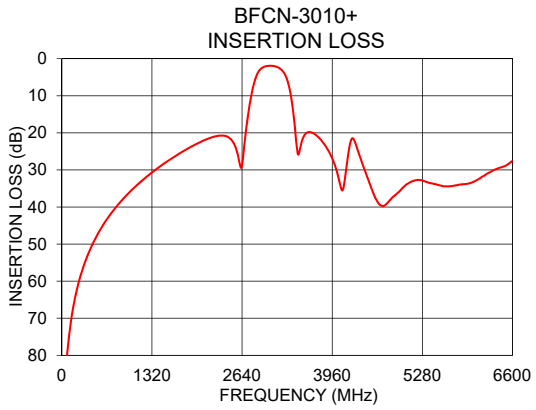
A	B	C	D	E	F	Wt.
.126	**.063**	**.037**	**.020**	**.032**	**.009**	grams
3.20	1.60	0.94	0.51	0.81	0.23	.020

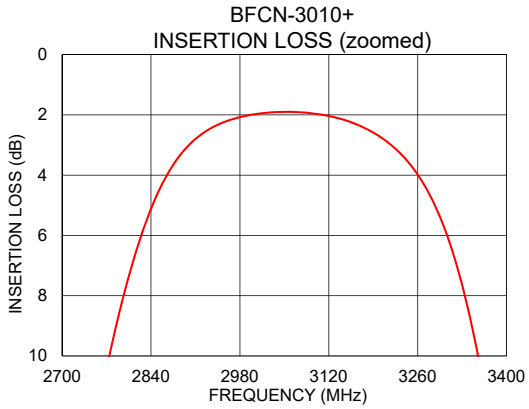
Band Pass Filter

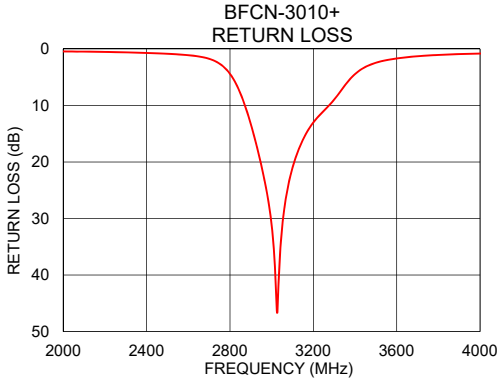
BFCN-3010+

TYPICAL PERFORMANCE DATA AT 25°C

Frequency (MHz)	Insertion Loss (dB)	Return Loss (dB)
50.00	88.02	0.13
790.00	40.12	0.26
1300.00	30.98	0.29
1530.00	27.85	0.31
2700.53	18.86	1.74
2920.00	2.63	15.99
2980.00	2.07	25.99
3010.00	1.96	35.17
3070.00	1.91	26.02
3100.00	1.96	21.02
3218.42	3.00	12.17
3550.00	20.71	1.98
4000.00	28.77	0.81
4450.00	30.76	0.58
4650.00	39.28	0.55
6600.00	27.46	0.83







NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.

C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

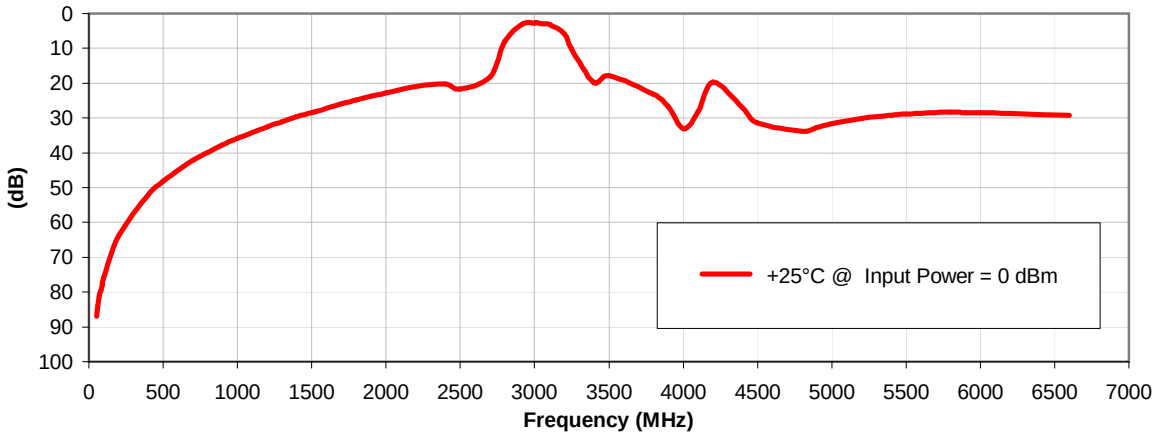
Ceramic Band Pass Filter BFCN-3010+

Typical Performance Data

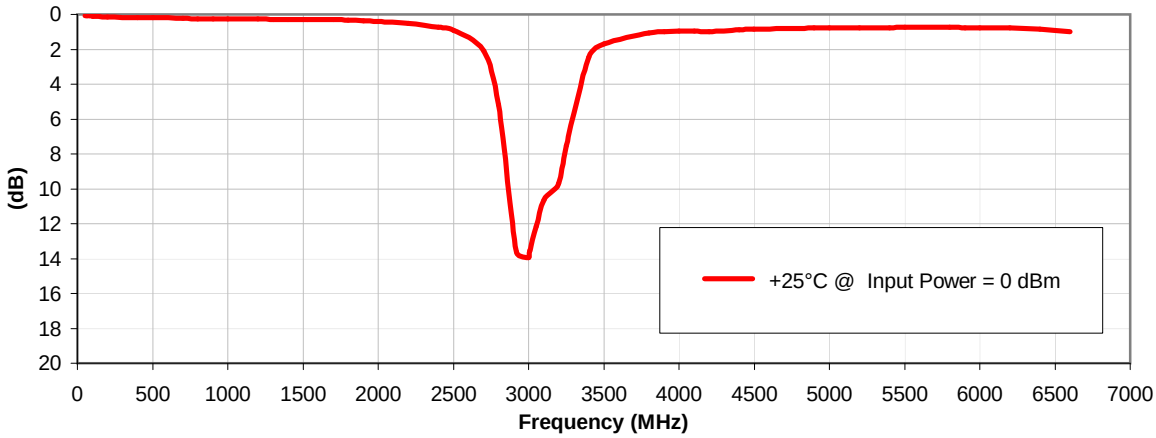
FREQ. (MHz)	INSERTION LOSS (dB) @ +25° C	INPUT RETURN LOSS (dB) @ +25° C	OUTPUT RETURN LOSS (dB) @ +25° C
50	86.94	0.07	0.00
60	83.91	0.07	0.00
70	81.23	0.08	0.00
80	79.41	0.09	0.01
90	77.94	0.09	0.01
100	75.85	0.10	0.01
200	63.94	0.14	0.02
400	51.96	0.19	0.06
500	48.07	0.20	0.08
700	42.17	0.23	0.14
800	39.80	0.24	0.17
900	37.74	0.25	0.20
1000	35.92	0.26	0.24
1200	32.60	0.27	0.30
1300	31.07	0.28	0.32
1400	29.67	0.28	0.34
1500	28.41	0.29	0.35
1530	28.16	0.30	0.36
1700	25.95	0.31	0.37
1800	24.82	0.34	0.38
1900	23.77	0.37	0.40
2000	22.82	0.41	0.42
2200	20.93	0.52	0.49
2400	20.28	0.72	0.68
2500	21.71	0.90	0.87
2700	18.27	2.10	2.11
2800	7.88	5.17	4.93
2920	3.03	13.61	10.63
3000	2.73	13.94	10.87
3010	2.56	13.54	10.61
3050	2.92	12.14	9.51
3100	3.15	10.63	7.93
3200	5.82	9.68	4.38
3250	10.05	7.53	2.63
3400	19.93	2.47	1.08
3500	17.74	1.69	0.93
3800	23.14	1.06	0.81
3900	26.59	0.99	0.91
4000	33.00	0.95	1.23
4100	28.17	0.94	2.73
4200	19.64	1.00	20.96
4400	26.98	0.89	1.24
4500	31.46	0.86	0.90
4800	33.88	0.80	0.66
4900	32.68	0.78	0.63
5000	31.70	0.77	0.62
5200	30.15	0.76	0.62
5400	29.21	0.76	0.65
5500	28.87	0.74	0.68
5800	28.33	0.75	0.76
5900	28.49	0.77	0.79
6000	28.50	0.77	0.82
6200	28.69	0.76	0.86
6400	29.12	0.83	0.89
6600	29.26	1.00	0.92

Typical Performance Curves

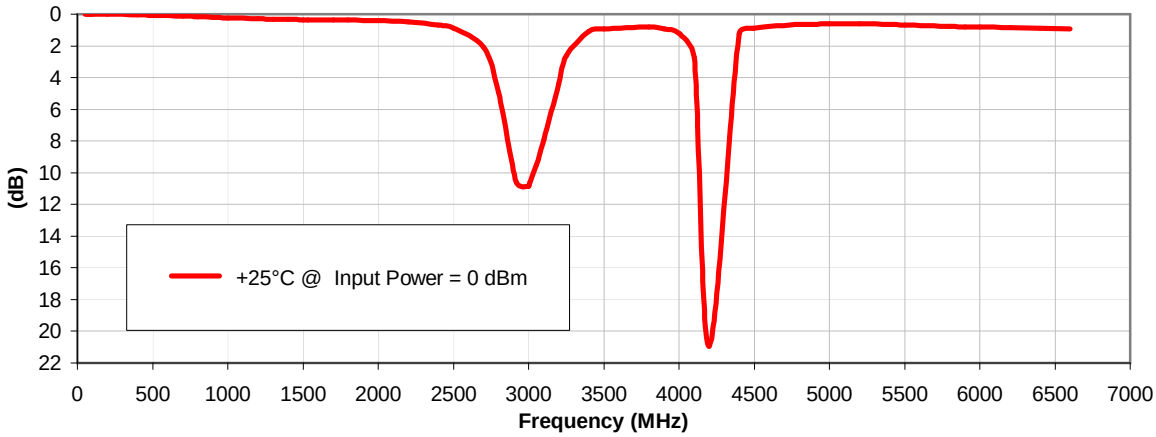
INSERTION LOSS vs. TEMPERATURE



INPUT RETURN LOSS vs. TEMPERATURE



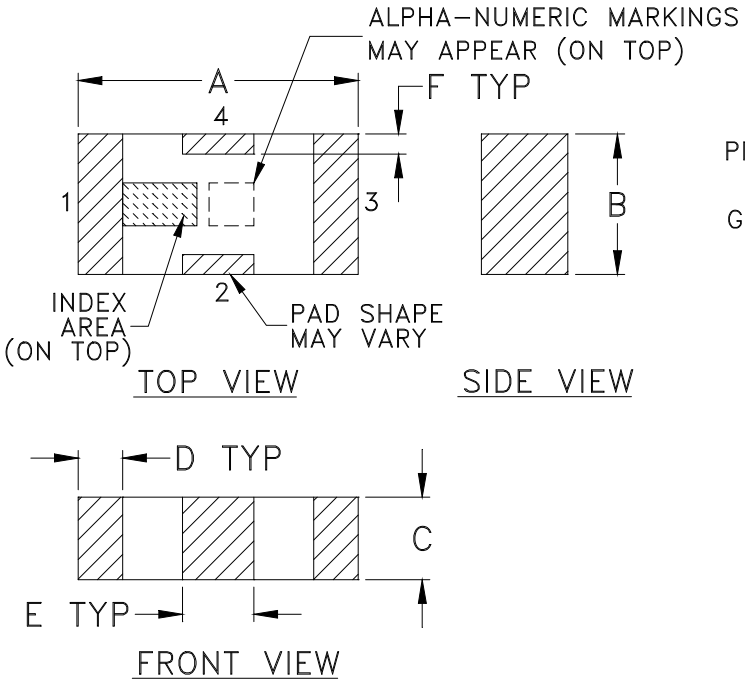
OUTPUT RETURN LOSS vs. TEMPERATURE



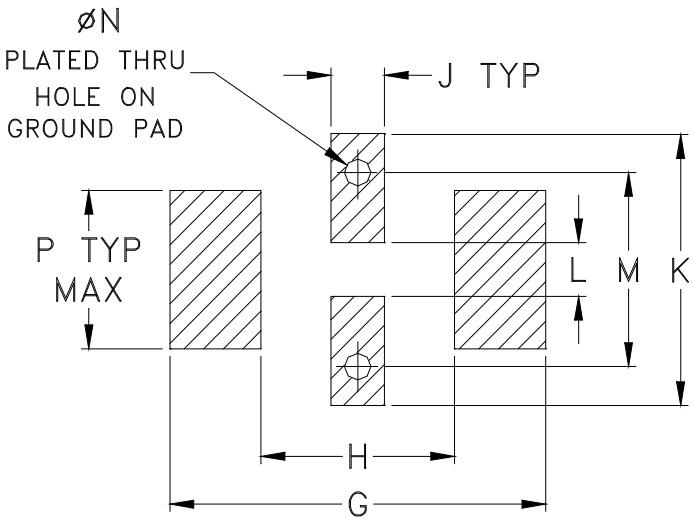
Case Style FV

FV1206

Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

CASE #	A	B	C	D	E	F	G	H	J	K	L	M	N	P	WT. GRAM
FV1206	.126 (3.20)	.063 (1.60)	.037 (0.94)	.020 (0.51)	.032 (0.81)	.009 (0.23)	.169 (4.29)	.087 (2.21)	.024 (0.61)	.122 (3.10)	.024 (0.61)	.087 (2.21)	.012 (0.30)	.071 (1.80)	.020

Dimensions are in inches (mm). Tolerances: 2 Pl. ± .01; 3 Pl. ± .005

Notes:

1. Open style, ceramic base.
2. Termination finish: **as shown below or indicated on Data Sheet.**
   For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
   For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.

Tape & Reel Packaging TR-F71

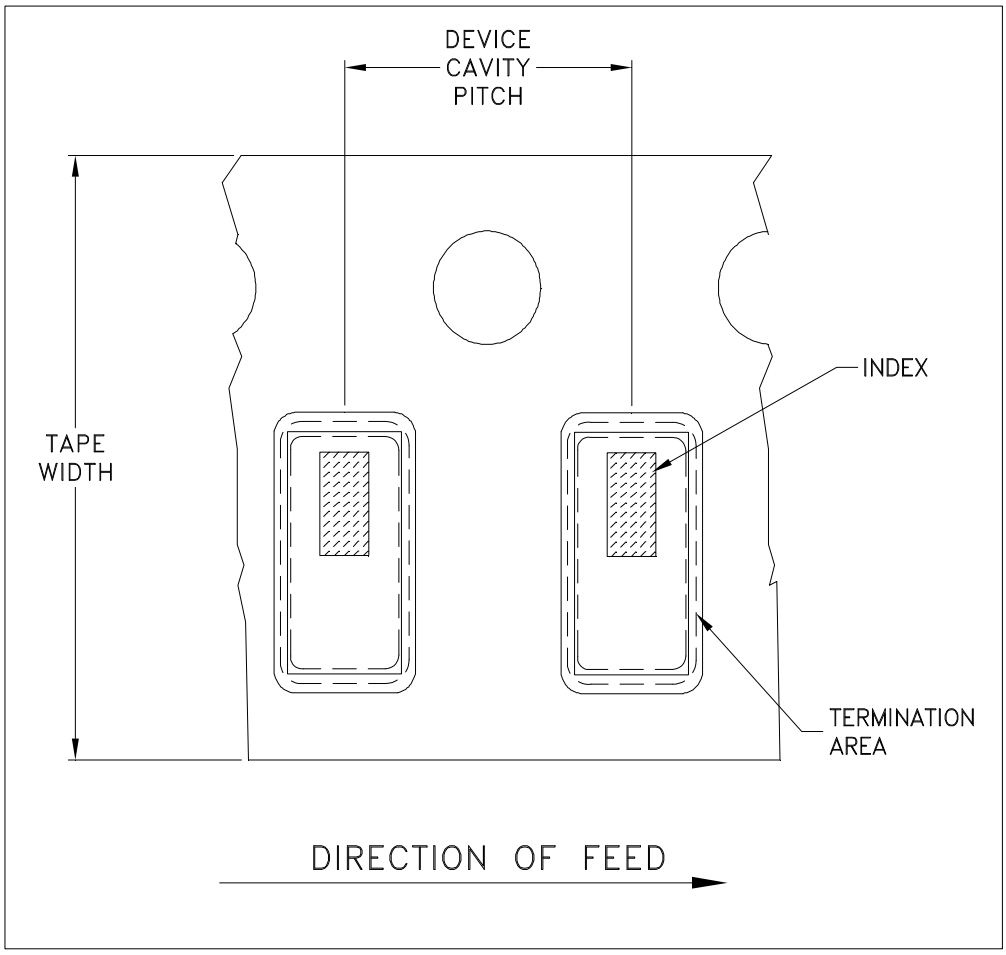


ILLUSTRATION 1

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	3000

Note: Please Consult individual model data sheet to determine device per reel availability.

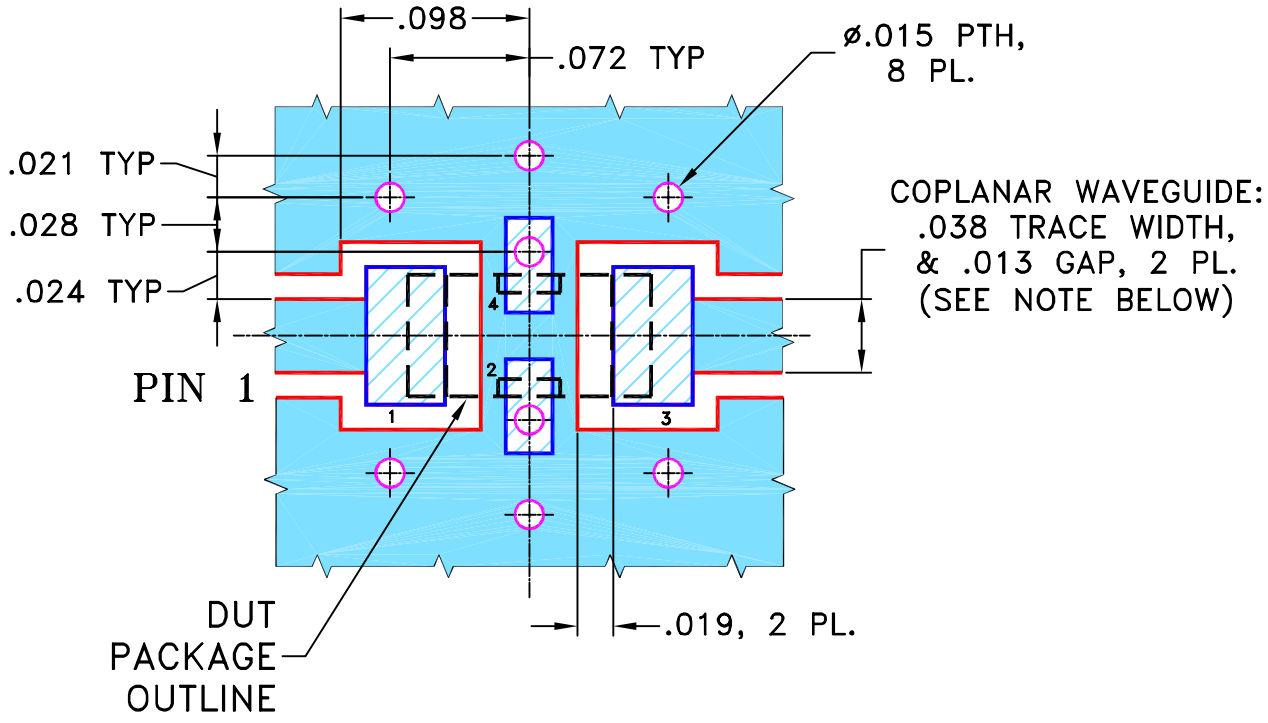
Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

THIRD ANGLE PROJECTION

REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M88634	NEW RELEASE	08/28/03	GF	ABD
A	M102713	ADDED "...WITH SMOBC"	01/17/06	MMG	IL

SUGGESTED MOUNTING CONFIGURATION FOR FV1206 CASE STYLE, "nx" PIN CONNECTION



NOTES:
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   COPPER: 1/2 OZ. EACH SIDE.
   FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	GF	08/27/03
TOLERANCES ON:	CHECKED	AV	08/28/03
2 PL DECIMALS ±	APPROVED	ABD	08/28/03
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

ASHEETA1.DWG REV:A DATE:01/12/95

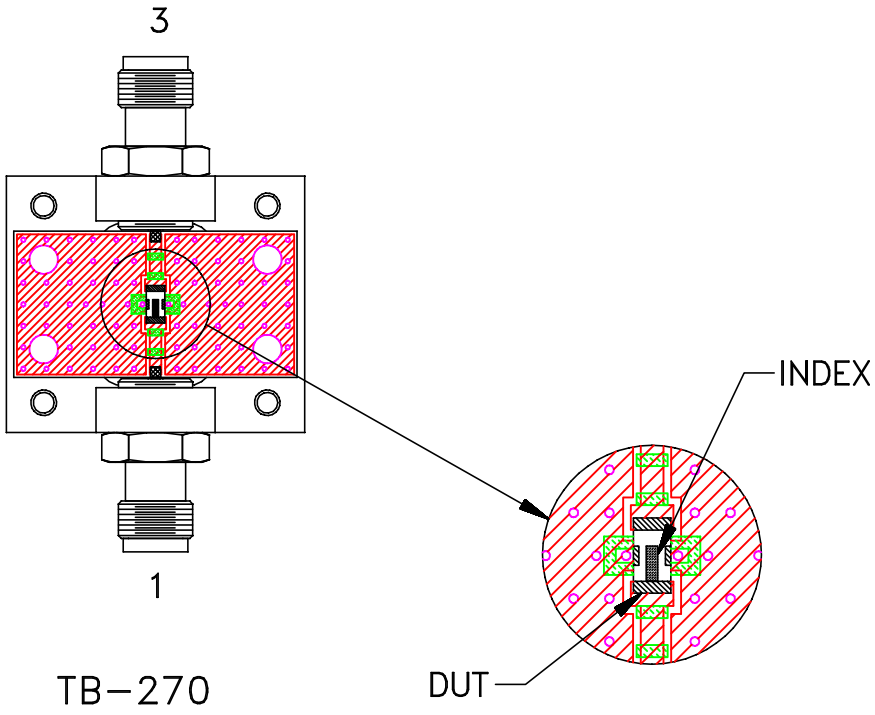
Mini-Circuits® 13 Neptune Avenue Brooklyn NY 11235

PL, nx, FV1206, LFCN/HFCN, TB-270

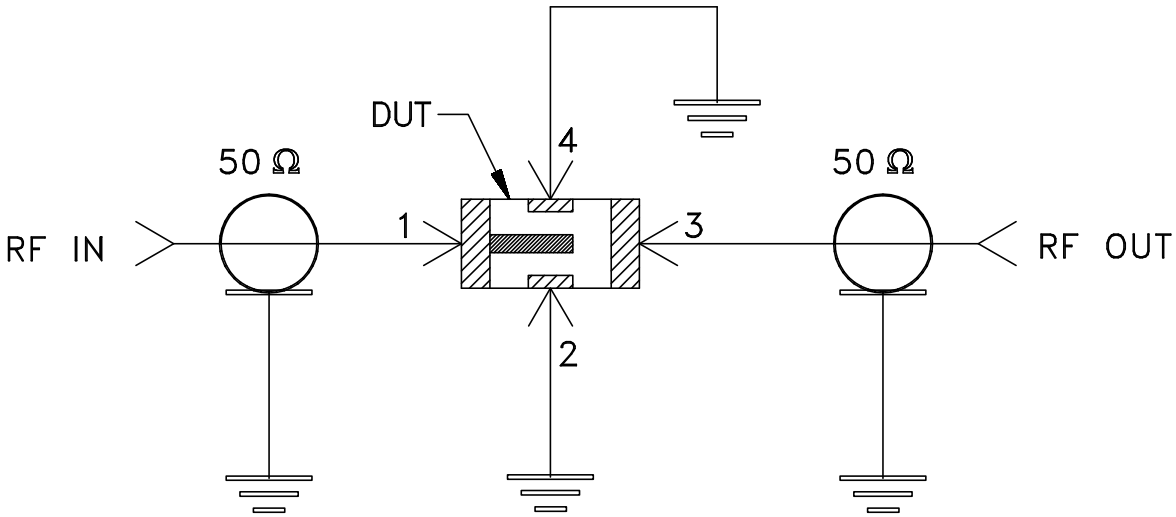
SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-137	A

FILE:	SCALE:	SHEET:
98PL137	10:1	1 OF 1

Evaluation Board and Circuit



TB-270



Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: ROGERS RO4350 or equivalent, Dielectric Constant=3.5, Thickness=.020 inch.

Mini-Circuits®

Mini-Circuits

Environmental Specifications ENV06

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A